

Characterization of Thin Film TiO₂ Photoelectrodes Prepared by Various ALD Procedures

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INTRODUCTION

Surface coverage by thin films is of great technological importance, because it improves mechanical, optical, and electrochemical properties of solid surfaces. We have shown, that atomic layer deposition (ALD) of titanium dioxide protects a semiconducting hematite electrode against corrosion and photocorrosion¹. The present work studies in detail the properties of ALD-TiO₂ layers deposited on FTO substrates.

EXPERIMENTAL/THEORETICAL STUDY

TiO₂ thin films (8, 20 and 50 nm) were deposited by various ALD procedures on FTO substrates. The structural and morphological properties of TiO₂ films were determined by X-ray diffraction (XRD) and atomic force microscopy (AFM). The conformability and quality of TiO₂ films deposited on FTO were quantified by electrochemical tests with suitable redox probes, such as [Fe(CN)₆]^{3-/4-}, which selectively distinguish the charge-transfer reactions occurring on TiO₂ surface and on the supporting FTO. The blocking properties of ALD-TiO₂ films are expressed as the effective pinhole area (EPA) determined from the peak current density of ferrocyanide oxidation³. Value of EPA indicates the percentage of FTO electrode area uncovered by TiO₂. Chemical stability in alkaline (phosphate buffer (pH 8)) and acidic solution (0.1M HClO₄) was studied. Dissolution rates of ALD-TiO₂ films were evaluated from concentration of the titanium in solution analyzed by inductively coupled plasma spectrometry (ICP). Photoelectrochemical properties and band gap of TiO₂ films were determined from incident photon to current conversion efficiency (IPCE) measurements.

RESULTS AND DISCUSSION

Two types of TiO₂/FTO electrodes were prepared by ALD with different deposition temperatures, 150 °C (LT-ALD-TiO₂) and 250 °C (HT-ALD-TiO₂). While both types of as-grown ALD-TiO₂ were quasi-amorphous, subsequent annealing at 500 °C /1 hour led to the formation of anatase crystalline structure in the case of LT-ALD-TiO₂, but for HT-ALD-TiO₂ neither anatase nor rutile were detected. AFM doesn't show significant difference in nanomorphology between different types of ALD-TiO₂/FTO samples. Blocking properties of 8 nm thick TiO₂ films are similar (EPA ≈ 8%) for both as-grown ALD-TiO₂ films, while for post-annealed films pinholes area increased to 20% and 45% for HT-ALD-TiO₂ and LT-ALD-TiO₂, respectively. All tested ALD-TiO₂ films were stable in phosphate buffer solution (pH 8). Exposure to acidic solution for 72 h caused dissolution of ~ 60% and 40% of TiO₂ film thickness in case of as-grown HT-ALD-TiO₂ and LT-ALD-TiO₂, respectively. Band gap energies determined from the electrochemical Tauc plot³ were found 3.0 and 3.1 eV for post-annealed HT-ALD-TiO₂ and LT-ALD-TiO₂, respectively.

CONCLUSION

As grown LT and HT ALD film are amorphous, post-annealing is necessary to obtain crystalline phase. ALD-TiO₂ films were chemically stable in phosphate buffer (pH 8), but dissolved in acidic solution.

REFERENCES

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